

Features

- Clocking Speeds up to 40MHz
- 15ns tr/tf at 2000pF CLOAD
- 0.5ns Rise and Fall Times Mismatch
- 0.5ns T_{ON}-T_{OFF} Prop Delay Mismatch
- 3.5pF Typical Input Capacitance
- 3.5A Peak Drive
- Low on Resistance of 3.5Ω
- High Capacitive Drive Capability
- Operates from 4.5V to 18V

Applications

- ATE/Burn-in Testers
- Level Shifting
- IGBT Drivers
- CCD Drivers

Ordering Information

Part No.	Package	Tape & Reel	Outline #
EL7156CN	8-Pin DIP	-	MDP0031
EL7156CS	8-Pin SOIC	-	MDP0027
EL7156CS-T7	8-Pin SOIC	7"	MDP0027
EL7156CS-T13	8-Pin SOIC	13"	MDP0027

General Description

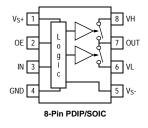
The EL7156C high-performance pin driver with tri-state is suited to many ATE and level-shifting applications. The 3.5A peak drive capability makes this part an excellent choice when driving high capacitance loads.

The output pin OUT is connected to input pins VH or VL respectively, depending on the status of the IN pin. When the OE pin is active low, the output is placed in the tri-state mode. The isolation of the output FETs from the power supplies enables VH and VL to be set independently, enabling level-shifting to be implemented. Related to the EL7155C, the EL7156C adds a lower supply pin V_S- and makes VL an isolated and independent input. This feature adds applications flexibility and improves switching response due to the increased enhancement of the output FETs.

This pin driver has improved performance over existing pin drivers. It is specifically designed to operate at voltages down to 0V across the switch elements while maintaining good speed and on-resistance characteristics.

Available in the 8-Pin SOIC and 8-Pin PDIP packages, the EL7156C is specified for operation over the -40° C to $+85^{\circ}$ C temperature range.

Pin Configuration



Absolute Maximum Ratings $(T_A = 25^{\circ}C)$

Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

Storage Temperature Range
Ambient operating Temperature
Operating Junction Temperature
Power Dissipation
Maximum ESD

-65°C to +150°C -40°C to +85°C 125°C see curves 2kV

Important Note:

Input Voltage

Supply Voltage (V_S+ to V_S-)

Continuous Output Current

All parameters having Min/Max specifications are guaranteed. Typ values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore: $T_J = T_C = T_A$.

+18V

200mA

Vs- -0.3V, Vs +0.3V

Electrical Characteristics

 $V_{S}\text{+}$ = +15V, VH = +15V, VL = 0V, $V_{S}\text{-}\text{=}0V,$ T_{A} = 25°C, unless otherwise specified

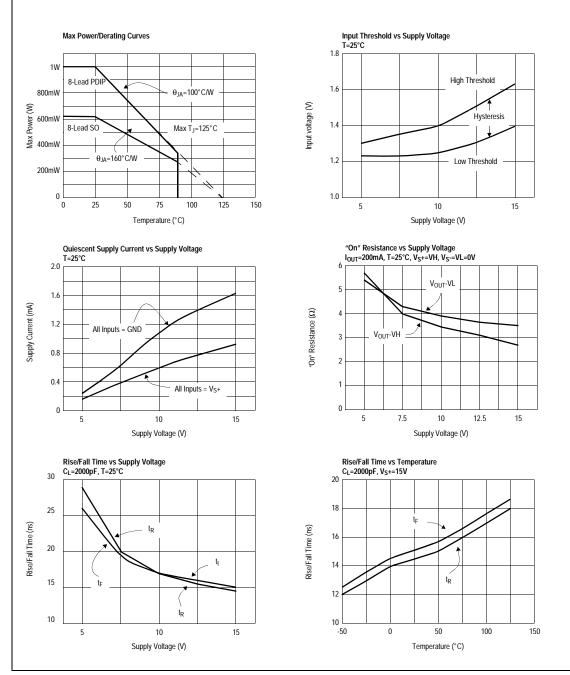
Parameter	Description Condition		Min	Тур	Max	Units
Input	· · · · ·					
V _{IH}	Logic '1' Input Voltage		2.4			V
I _{IH}	Logic '1' Input Current	urrent $V_{IH} = V_S +$		0.1	10	μΑ
V _{IL}	Logic '0' Input Voltage				0.8	v
I _{IL}	Logic '0' Input Current	$V_{IL} = 0V$		0.1	10	μΑ
CIN	Input Capacitance			3.5		pF
R _{IN}	Input Resistance			50		MΩ
Output	· · · ·				•	•
ROVH	ON Resistance VH to OUT	$I_{OUT} = -200 \text{ mA}$		2.7	4.5	Ω
R _{OVL}	ON Resistance VL to OUT	$I_{OUT} = +200 \text{ mA}$	3.5		5.5	Ω
I _{OUT}	Output Leakage Current	OE = 0V, OUT = VH/VL		0.1	10	μΑ
I _{PK}	Peak Output Current	Source		3.5		Α
	(linear resistive operation)	Sink		3.5		А
I _{DC}	Continuous Output Current	Source/Sink	200			mA
Power Supply	· · · ·				•	•
IS	Power Supply Current	$Inputs = V_S +$	1.3		3	mA
I _{VH}	Off Leakage at VH and VL	VH, VL = 0V		4	10	μΑ
Switching Cha	racteristics				•	•
t _R	Rise Time	C _L =2000 pF		14.5		ns
t _F	Fall Time	$C_{L} = 2000 \text{ pF}$	15			ns
t _{RFdelta}	t _R , t _F Mismatch	$C_L = 2000 \text{ pF}$	0.5			ns
t _{D-1}	Turn-Off Delay Time	$C_{L} = 2000 \text{ pF}$	C _L = 2000 pF 9.5			ns
t _{D-2}	Turn-On Delay Time	$C_L = 2000 \text{ pF}$	10			ns
t _{Ddelta}	t _{D-1} -t _{D-2} Mismatch	$C_L = 2000 \text{ pF}$	0.5			ns
t _{D-3}	Tri-State Delay Enable			10		ns
t _{D-4}	Tri-State Delay Disable		10		ns	

Electrical Characteristics

 V_S+ = +5V, VH = +5V, VL = -5V, V_S- = -5V, T_A = 25°C, unless otherwise specified

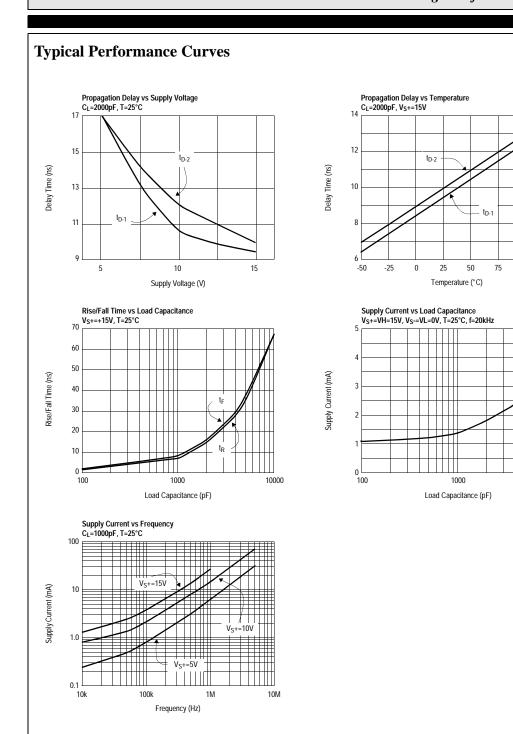
Parameter	Description	Condition	Min	Тур	Max	Units
Input						
V _{IH}	Logic '1' Input Voltage		2.0			V
I _{IH}	Logic '1' Input Current	$V_{IH} = V_S +$		0.1	10	μΑ
V _{IL}	Logic '0' Input Voltage				0.8	V
I _{IL}	Logic '0' Input Current	$V_{IL} = 0V$		0.1	10	μΑ
C _{IN}	Input Capacitance			3.5		pF
R _{IN}	Input Resistance			50		MΩ
Output						
R _{OVH}	ON Resistance VH to OUT	$I_{OUT} = -200 \text{ mA}$		3.4	5	Ω
R _{OVL}	ON Resistance VL to OUT	$I_{OUT} = +200 \text{ mA}$	4		6	Ω
IOUT	Output Leakage Current	OE = 0V, OUT = VH/VL		0.1	10	μΑ
I _{PK}	Peak Output Current	Source		3.5		Α
	(linear resistive operation)	Sink		3.5		А
I _{DC}	Continuous Output Current	Source/Sink	200			mA
Power Supply						
IS	Power Supply Current	$Inputs = V_S +$	$uts = V_S +$		2.5	mA
V _H	Off Leakage at VH and VL	VH, VL = $0V$		4	10	μΑ
Switching Cha	racteristics					
t _R	Rise Time	$C_L = 2000 \text{ pF}$	17			ns
tF	Fall Time	$C_L = 2000 \text{ pF}$	17			ns
t _{RFdelta}	t _R , t _F Mismatch	$C_L = 2000 \text{ pF}$	0			ns
t _{D-1}	Turn-Off Delay Time	clay Time $C_L = 2000 \text{ pF}$ 11.5		11.5		ns
tD-2	Turn-On Delay Time	$C_L = 2000 \text{ pF}$	12			ns
t _{Ddelta}	t _{D-1} -t _{D-2} Mismatch	$C_L = 2000 \text{ pF}$	0.5			ns
t _{D-3}	Tri-State Delay Enable			10		ns
t _{D-4}	Tri-State Delay Disable 10			ns		

Typical Performance Curves



100 125

10000



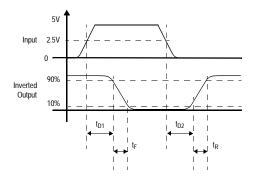
Truth Table

OE	IN	OUT
0	0	Tri-state
0	1	Tri-state
1	0	VH
1	1	VL

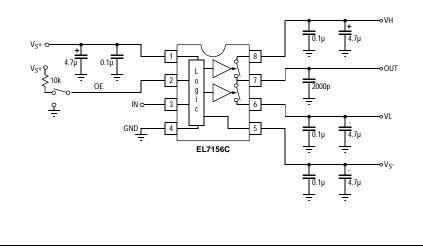
Operating Voltage Range

PIN	MIN	MAX
GND - V _S -	-5	0
V _S + - V _S -	5	18
VH - VL	-18	18
V _S + - VH	0	18
V _S + - GND	5	18

Timing Diagram



Standard Test Configuration



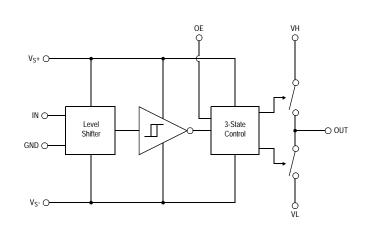
Pin Description

Pin	Name	Function	Equivalent Circuit
l	V _S +	Positive Supply Voltage	
	OE	Output Enable	INPUT O
;	IN	Input	Reference Circuit 1
4	GND	Ground	
5	Vs-	Negative Supply Voltage	
6 7	VL	Lower Output Voltage	
0			VH
8	VH	High Output Voltage	

EL7156C

EL7156C High Performance Pin Driver

Block Diagram



Application Information

Product Description

The EL7156C is a high performance 40MHz pin driver. It contains two analog switches connecting VH and VL to OUT. Depending on the value of the IN pin, one of the two switches will be closed and the other switch open. An output enable (OE) is also supplied which opens both switches simultaneously.

Due to the topology of the EL7156C, both the VH and VL pins can be connected to any voltage between the V_{S^+} and V_{S^-} pins.

The EL7156C is available in both the 8-pin SOIC and the 8-pin PDIP packages. The relevant package should be chosen depending on the calculated power dissipation.

Supply Voltage Range and Input Compatibility

The EL7156C is designed for operation on supplies from 5V to 15V (4.5V to 18V maximum). The table on page 6 shows the specifications for the relationship between the V_{S+} , V_{S-} , VH, VL and GND pins.

All input pins are compatible with both 3V and 5V CMOS signals. With a positive supply (V_S +) of 5V, the EL7156C is also compatible with TTL inputs.

Power Supply Bypassing

When using the EL7156C, it is very important to use adequate power supply bypassing. The high switching currents developed by the EL7156C necessitate the use of a bypass capacitor between the supplies (V_S + & V_S -) and GND pins. It is recommended that a 2.2 μ F tantalum capacitor be used in parallel with a 0.1 μ F low-inductance ceramic MLC capacitor. These should be placed as close to the supply pins as possible. It is also recommended that the VH and VL pins have some level of bypassing, especially if the EL7156C is driving highly capacitive loads.

Power Dissipation Calculation

When switching at high speeds, or driving heavy loads, the EL7156C drive capability is limited by the rise in die temperature brought about by internal power dissipation. For reliable operation die temperature must be kept below T_{jmax} (125°C). It is necessary to calculate the power dissipation for a given application prior to selecting the package type.

Power dissipation may be calculated:

$$PD = (V_{S} \times I_{S}) + (C_{INT} \times V_{S}^{2} \times f) + (C_{L} \times V_{OUT}^{2} \times f)$$

where:

- + V_S is the total power supply to the EL7156C (from V_S + to GND),
- V_{out} is the swing on the output (VH VL),
- C_L is the load capacitance,
- C_{INT} is the internal load capacitance (50pF max.),
- I_S is the quiescent supply current (3mA max.) and
- f is frequency

Having obtained the application's power dissipation, a maximum package thermal coefficient may be determined, to maintain the internal die temperature below T_{jmax} :

$$\theta_{ja} = \frac{T_{jmax} - T_{max}}{PD}$$

where:

- T_{jmax} is the maximum junction temperature (125°C),
- T_{max} is the maximum operating temperature,
- PD is the power dissipation calculated above,
- θ_{ja} thermal resistance on junction to ambient.

 θ_{ja} is 160°C/W for the SO8 package and 100°C/W for the PDIP8 package when using a standard JEDEC JESD51-3 single-layer test board. If T_{jmax} is greater than 125°C when calculated using the equation above, then one of the following actions must be taken:

- Reduce θ_{ja} the system by designing more heat-sinking into the PCB (as compared to the standard JEDEC JESD51-3)
- Use the PDIP8 instead of the SO8 package
- De-rate the application either by reducing the switching frequency, the capacitive load, or the maximum operating (ambient) temperature (T_{max})

General Disclaimer

Specifications contained in this data sheet are in effect as of the publication date shown. Elantec, Inc. reserves the right to make changes in the circuitry or specifications contained herein at any time without notice. Elantec, Inc. assumes no responsibility for the use of any circuits described herein and makes no representations that they are free from patent infringement.



Elantec Semiconductor, Inc.

675 Trade Zone Blvd. Milpitas, CA 95035 Telephone: (408) 945-1323 (888) ELANTEC Fax: (408) 945-9305 European Office: +44-118-977-6080 Japan Technical Center: +81-45-682-5820

WARNING - Life Support Policy

Elantec, Inc. products are not authorized for and should not be used within Life Support Systems without the specific written consent of Elantec, Inc. Life Support systems are equipment intended to support or sustain life and whose failure to perform when properly used in accordance with instructions provided can be reasonably expected to result in significant personal injury or death. Users contemplating application of Elantec, Inc. Products in Life Support Systems are requested to contact Elantec, Inc. factory headquarters to establish suitable terms & conditions for these applications. Elantec, Inc.'s warranty is limited to replacement of defective components and does not cover injury to persons or property or other consequential damages.